

C4MS036120K1

Silicon Carbide Power MOSFET
Switching Optimized 1200V 36mΩ Industrial
N-Channel Enhancement Mode

Features

- Industry compatible drive voltage 15V...18V/-5V...0V
- Soft body diode with low Vds overshoot and ringing
- Low Rds(on) at high operating temperatures
- Improved device capacitances ratio (Ciss/Crss)
- High transient voltage robustness with improved lifetime
- Halogen free, RoHS compliant

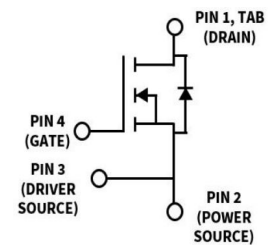
Benefits

- Higher efficiency with lower switching losses and EMI
- Faster switching operation enabling high power density
- Enables system level price performance optimization
- Reduction in system level cooling requirements

Typical Applications

- EV Chargers
- Solar/ESS
- Motor Control
- Industrial Power Supplies
- High Voltage DC/DC Converters

Package



Orderable Part number	Package type	Marking
C4MS036120K1	TO-247-4 LP	C4MS036120K1

Key Parameters

Parameter	Symbol	Min.	Typ.	Max	Unit	Conditions	Note
Drain - Source Voltage	V_{DS}			1200	V		
Transient Drain - Source Voltage				1300		<100hrs of lifetime	Note 1
Maximum Gate - Source Voltage	$V_{GS(max)}$	-10		+23			Note 2
DC Continuous Drain Current	I_D		60		A	$V_{GS} = 18V, T_C = 25^\circ C, T_J \leq 175^\circ C$	Note 3
			44			$V_{GS} = 18V, T_C = 100^\circ C, T_J \leq 175^\circ C$	
Pulsed Drain Current	I_{DM}			193		t_{Pmax} limited by T_{Jmax} $V_{GS} = 18V, T_C = 25^\circ C$	
Power Dissipation	P_D		272		W	$T_C = 25^\circ C, T_J = 175^\circ C$	Note 4
Operating Junction and Storage Temperature	T_J, T_{stg}	-40		+175	$^\circ C$		
Solder Temperature	T_L			260		According to JEDEC J-STD-020	

Note (1): 100 hours of total accumulated lifetime of the product.

Note (2): When applying IPC-9592B or OCP M-CRPS derating standards, a maximum Gate-Source voltage (Vgs) of +25V is permissible.

Note (3): Current limit calculated by $I_{D(max)} = \sqrt{(P_D / R_{DS(typ)}) \cdot (T_{J(max)} - T_{D(max)})}$

Note(4): $P_D = (T_J - T_C) / R_{th(JC,typ)}$


Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			V	$V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$	
$V_{GS(th)}$	Gate Threshold Voltage	2	2.6	3.9	V	$V_{DS} = V_{GS}, I_D = 7.6\text{ mA}$	Fig. 11
			2.0		V	$V_{DS} = V_{GS}, I_D = 7.6\text{ mA}, T_J = 175^\circ\text{C}$	
I_{DSS}	Zero Gate Voltage Drain Current		1	50	μA	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$	
I_{GSS}	Gate-Source Leakage Current		10	250	nA	$V_{GS} = 18\text{ V}, V_{DS} = 0\text{ V}$	
$V_{GS(op)}$	Recommended Turn on Gate-Source Voltage		+15...+18		V		Refer to PRD-09634
	Recommended Turn off Gate-Source Voltage		-5...0				
$R_{DS(on)}$	Drain-Source On-State Resistance		36	47	m Ω	$V_{GS} = 18\text{ V}, I_D = 27.6\text{ A}$	Fig. 4, 5, 6
			66			$V_{GS} = 18\text{ V}, I_D = 27.6\text{ A}, T_J = 175^\circ\text{C}$	
			42			$V_{GS} = 15\text{ V}, I_D = 27.6\text{ A}$	
g_{fs}	Transconductance		20		S	$V_{DS} = 20\text{ V}, I_D = 27.6\text{ A}, T_J = 25^\circ\text{C}$	Fig. 7
			19			$V_{DS} = 20\text{ V}, I_D = 27.6\text{ A}, T_J = 175^\circ\text{C}$	
$R_{DS(on)Tempco}$	On resistance temperature coefficient		1.88			$V_{GS} = 18\text{ V}, I_D = 27.6\text{ A}$	Note 5
C_{iss}	Input Capacitance		2164		pF	$V_{GS} = 0\text{ V}, V_{DS} = 1000\text{ V}$ $f = 100\text{ kHz}$ $V_{AC} = 25\text{ mV}$	Fig. 17, 18
C_{oss}	Output Capacitance		72				
C_{rss}	Reverse Transfer Capacitance		3.2				
C_{iss}/C_{rss}	Capacitance Ratio		630				Note 6
E_{oss}	C_{oss} Stored Energy		46		μJ		Fig. 16
$C_{o(er)}$	Effective Output Capacitance (Energy Related)		106		pF	$V_{GS} = 0\text{ V}, V_{DS} = 0...800\text{ V}$	
$C_{o(tr)}$	Effective Output Capacitance (Time Related)		173				
E_{on}	Turn-On Switching Energy (Body Diode FWD) $T_J = 25^\circ\text{C}$		303		μJ	$V_{DS} = 800\text{ V}, V_{GS} = -4\text{ V}/18\text{ V}, I_D = 27.6\text{ A},$ $R_{G(ext)} = 2\text{ }\Omega, L_\sigma = 25\text{ nH}$	Fig. 26, 29, 31
	$T_J = 175^\circ\text{C}$		393				
E_{off}	Turn-Off Switching Energy (Body Diode FWD) $T_J = 25^\circ\text{C}$		18				Fig. 26, 29, 32
	$T_J = 175^\circ\text{C}$		26				
$t_{d(on)}$	Turn-On Delay Time		12		ns	$V_{DD} = 800\text{ V}, V_{GS} = -4\text{ V}/18\text{ V}$ $I_D = 27.6\text{ A}, R_{G(ext)} = 2\text{ }\Omega,$ Timing relative to V_{DS} Inductive load	Fig. 27, 28
t_r	Rise Time		3				
$t_{d(off)}$	Turn-Off Delay Time		29				
t_f	Fall Time		4				
$R_{G(int)}$	Internal Gate Resistance		2.4		Ω	$f = 1\text{ MHz}$	
Q_{gs}	Gate to Source Charge		24		nC	$V_{DS} = 800\text{ V}, V_{GS} = -4\text{ V}/18\text{ V}$ $I_D = 27.6\text{ A}, T_J = 25^\circ\text{C}$ Per IEC60747-8-4 pg 21	Fig. 12
Q_{gd}	Gate to Drain Charge		23				
Q_g	Total Gate Charge		88				

Note (5): $R_{DS(on)Tempco}$ refers to $R_{DS(on)}$ at 175°C / $R_{DS(on)}$ at 25°C , C4MS 1200V product family value

Note (6): Capacitance ratio is a FOM for Partial turn-on immunity PRD-06933, C4MS 1200V product family value

$C_{o(er)}$, a lumped capacitance that gives the same stored energy as C_{oss} while V_{ds} is rising from 0 to 800V

$C_{o(tr)}$, a lumped capacitance that gives the same charging time as C_{oss} while V_{ds} is rising from 0 to 800V



Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V _{SD}	Diode Forward Voltage	5.2		V	V _{GS} = -4 V, I _{SD} = 13.8 A, T _j = 25 °C	Fig. 8, 9, 10
		4.6		V	V _{GS} = -4 V, I _{SD} = 13.8 A, T _j = 175 °C	
I _S	Continuous Diode Forward Current	40		A	V _{GS} = -4 V, T _c = 25°C	
I _{SM}	Diode Pulse Current		193	A	V _{GS} = -4 V, pulse width t _p limited by T _{jmax}	
t _{rr}	Reverse Recovery Time	11		ns	V _{GS} = -4 V, I _S = 27.6 A, V _{SD} = 800V T _j = 175°C, diF/dt = 7.6 A/ns	
Q _{rr}	Reverse Recovery Charge	335		nC		
I _{RRM}	Peak Reverse Recovery current	49		A		
E _{RR}	Reverse recovery Energy				V _{DS} = 800 V, I _D = 27.6 A,	
	T _j = 25C	29		μJ	V _{GS} = -4V/18V, R _{Gi(on)} = 2 Ω, Lσ = 25nH	
	T _j = 175C	35				

Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Test Conditions	Note
R _{θJC}	Thermal Resistance from Junction to Case	0.55	°C/W		

Typical Performance

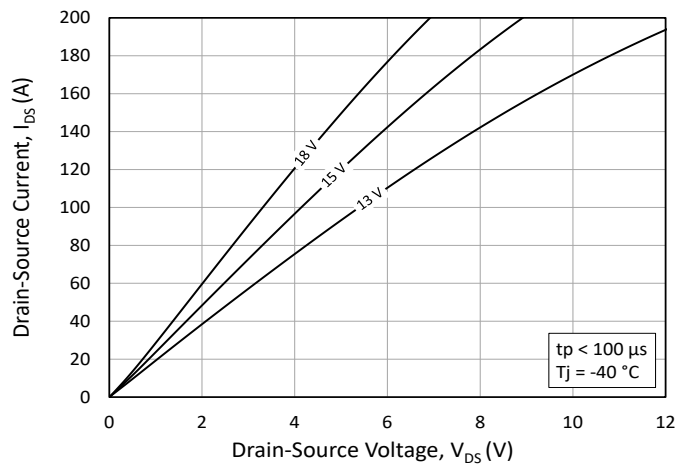
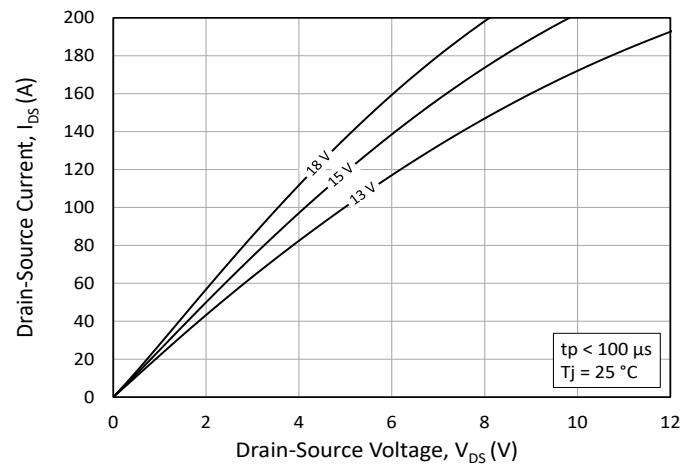
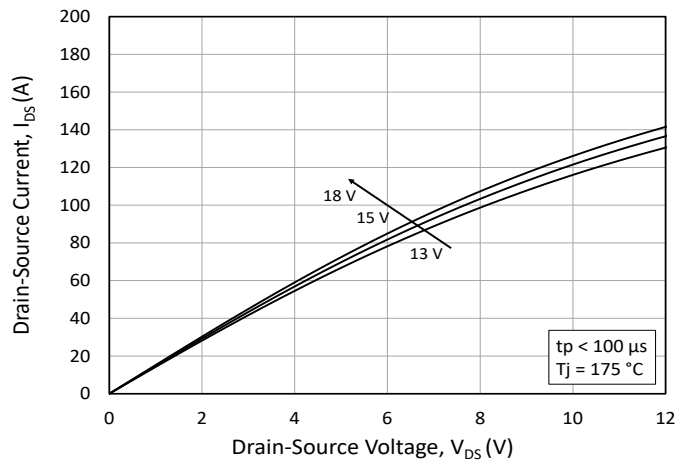
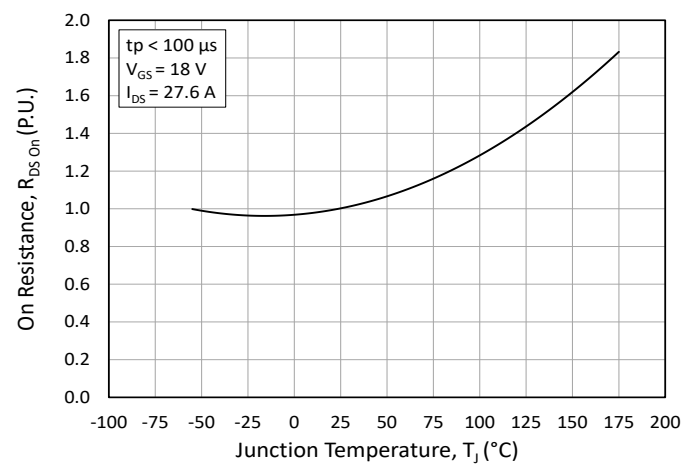
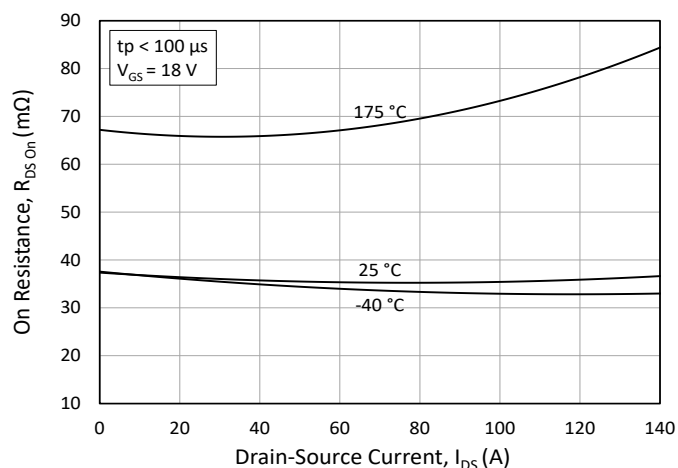
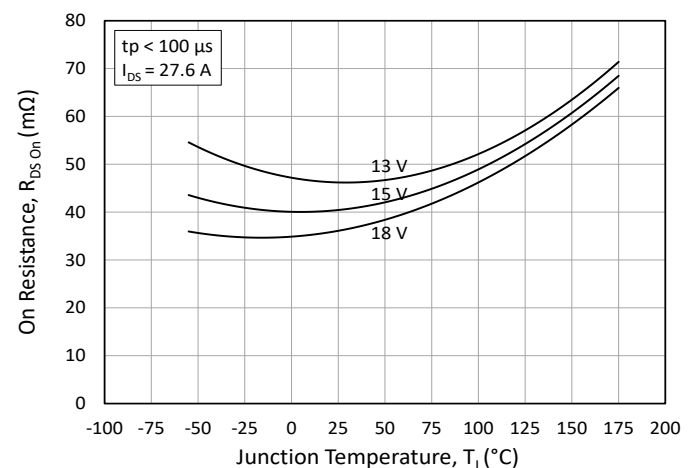
Figure 1. Output Characteristics $T_j = -40^{\circ}\text{C}$ Figure 2. Output Characteristics $T_j = 25^{\circ}\text{C}$ Figure 3. Output Characteristics $T_j = 175^{\circ}\text{C}$ 

Figure 4. Normalized On-Resistance vs. Temperature

Figure 5. On-Resistance vs. Drain Current
For Various TemperaturesFigure 6. On-Resistance vs. Temperature
For Various Gate Voltage

Typical Performance

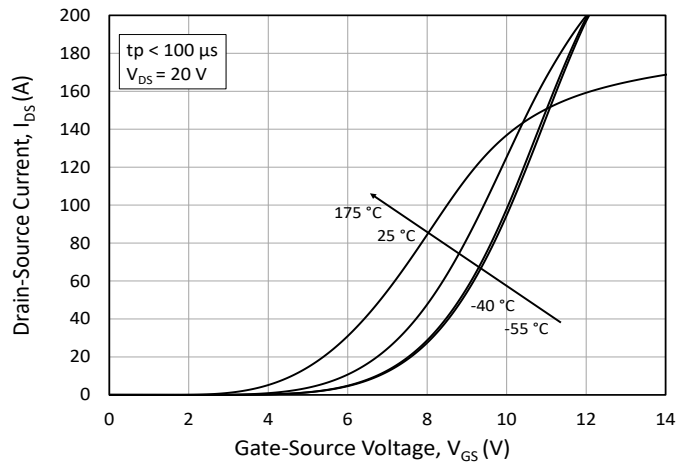


Figure 7. Transfer Characteristic for Various Junction Temperatures

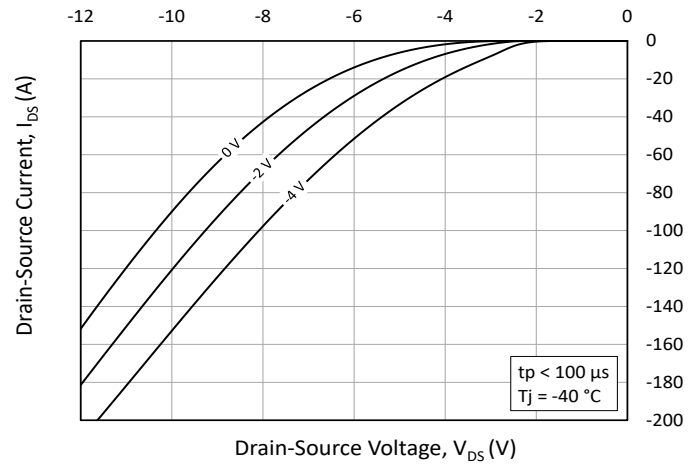


Figure 8. Body Diode Characteristic at -40 °C

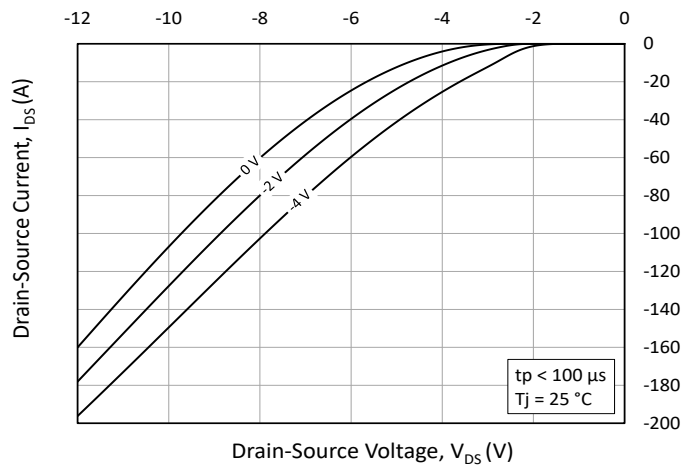


Figure 9. Body Diode Characteristic at 25 °C

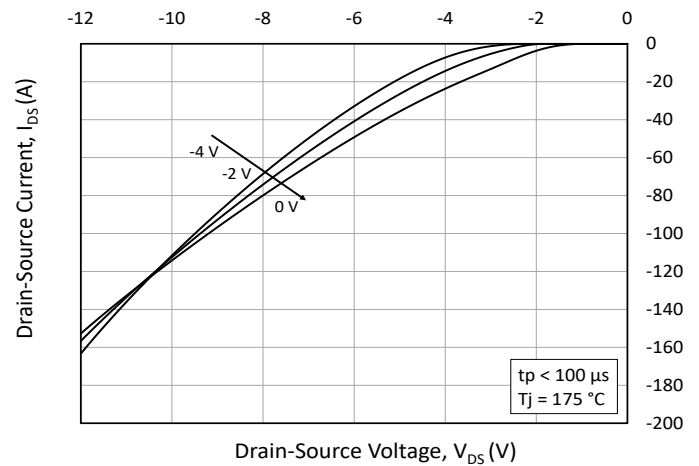


Figure 10. Body Diode Characteristic at 175 °C

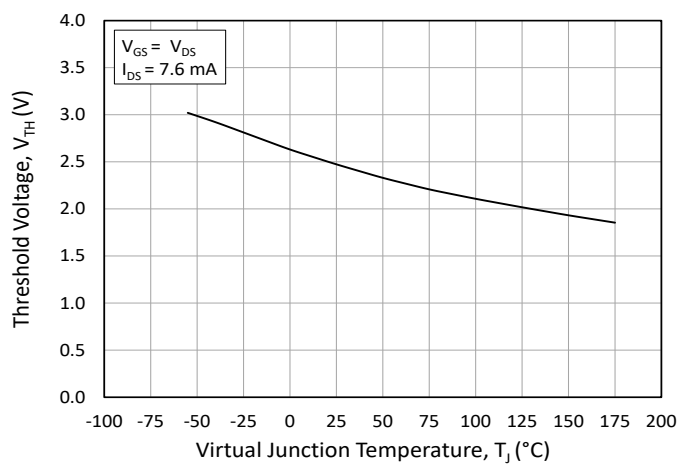


Figure 11. Threshold Voltage vs. Temperature

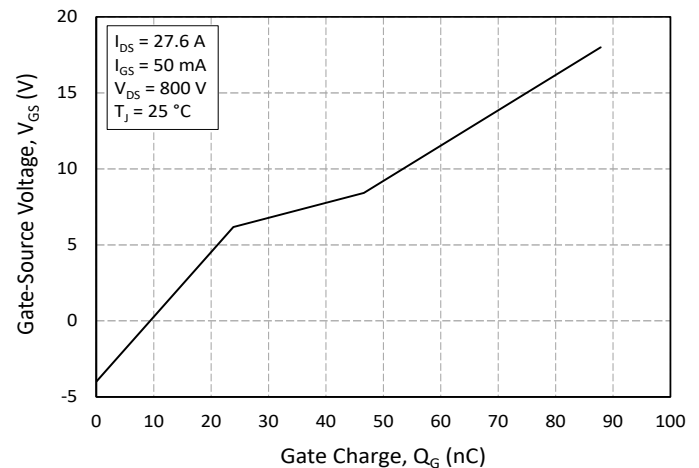


Figure 12. Gate Charge Characteristics

Typical Performance

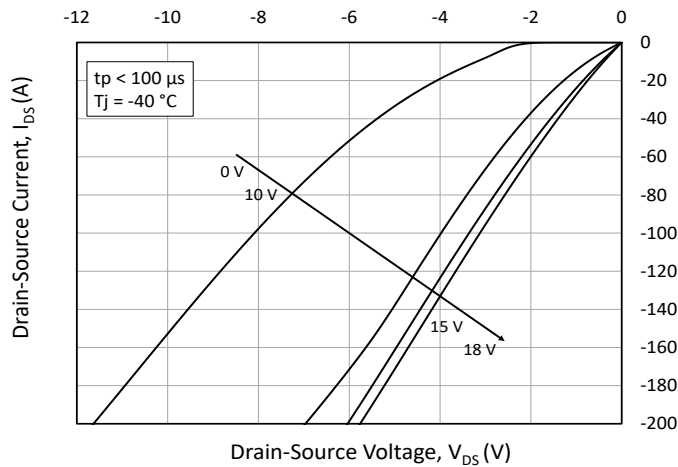


Figure 13. 3rd Quadrant Characteristic at -40°C

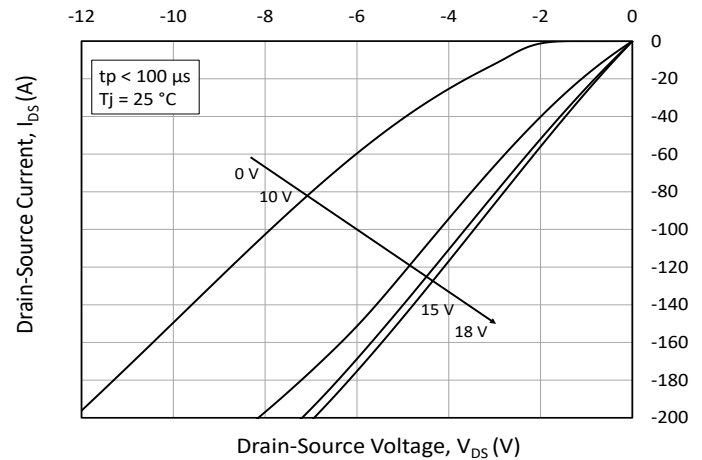


Figure 14. 3rd Quadrant Characteristic at 25°C

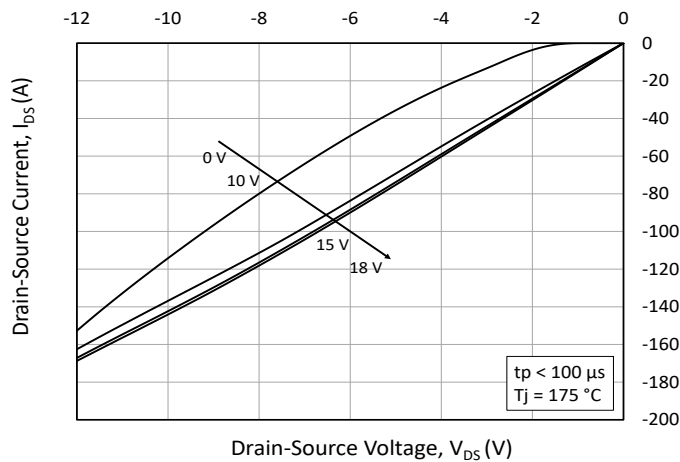


Figure 15. 3rd Quadrant Characteristic at 175°C

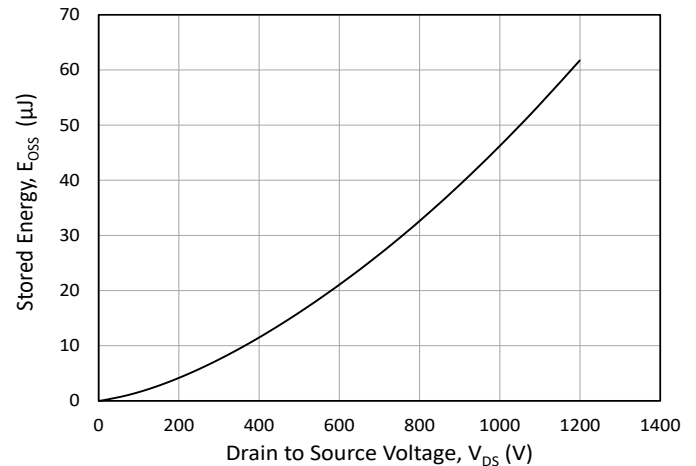


Figure 16. Output Capacitor Stored Energy

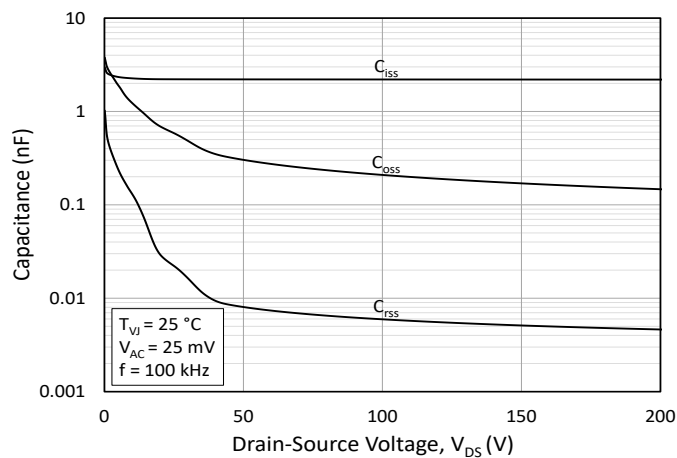


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200 V)

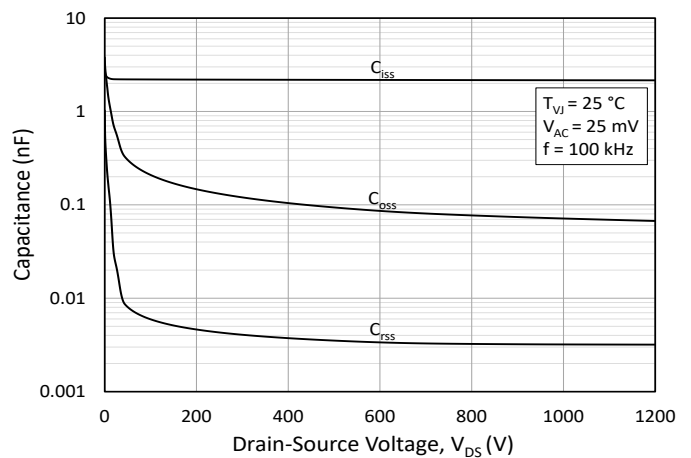


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200 V)

Typical Performance

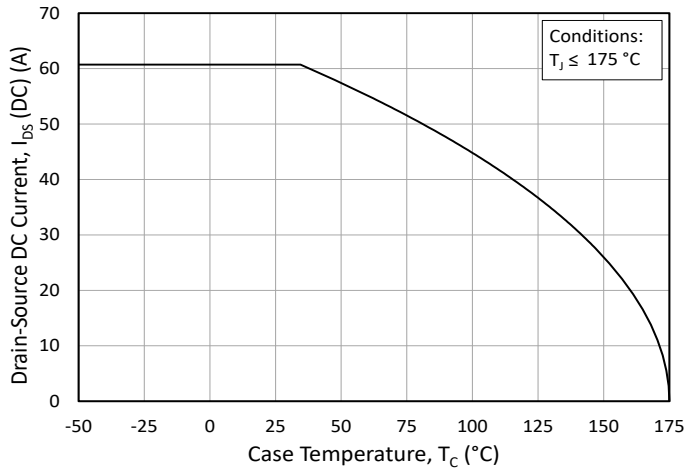


Figure 19. Continuous Drain Current Derating vs. Case Temperature

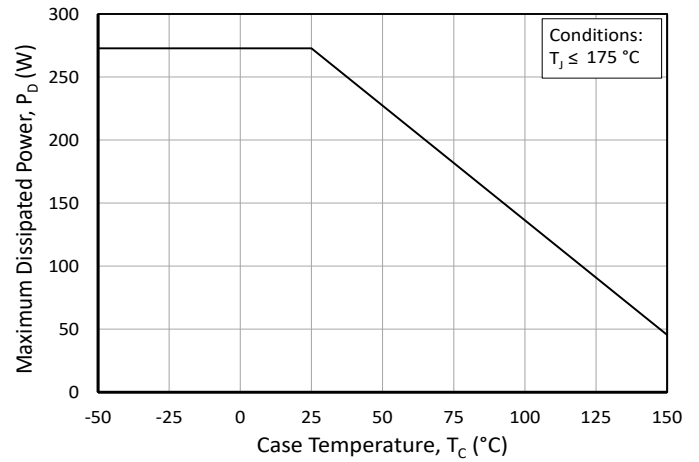


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

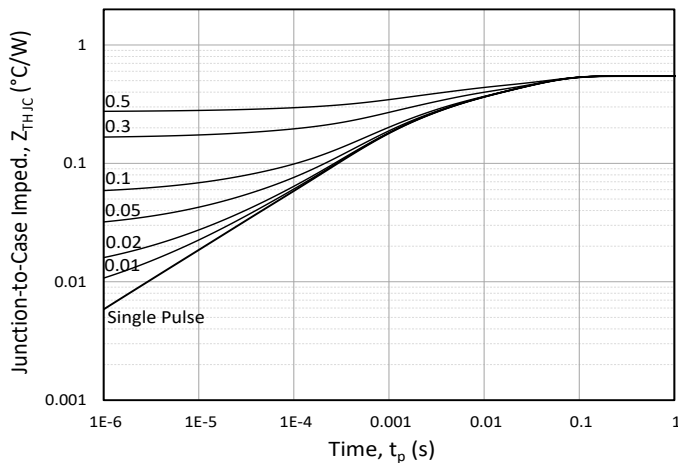


Figure 21. Transient Thermal Impedance (Junction - Case)

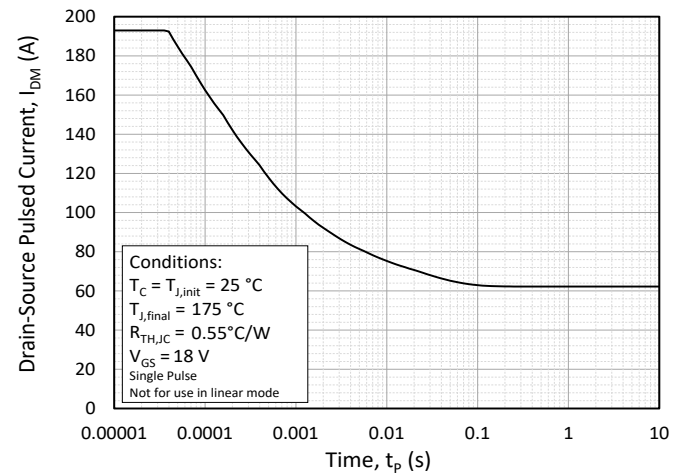
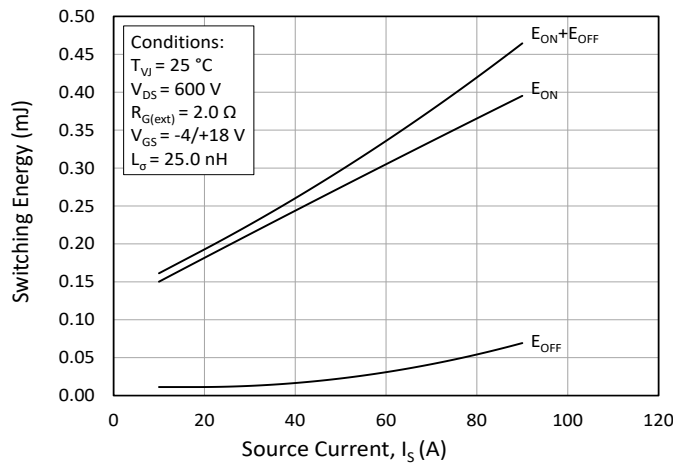
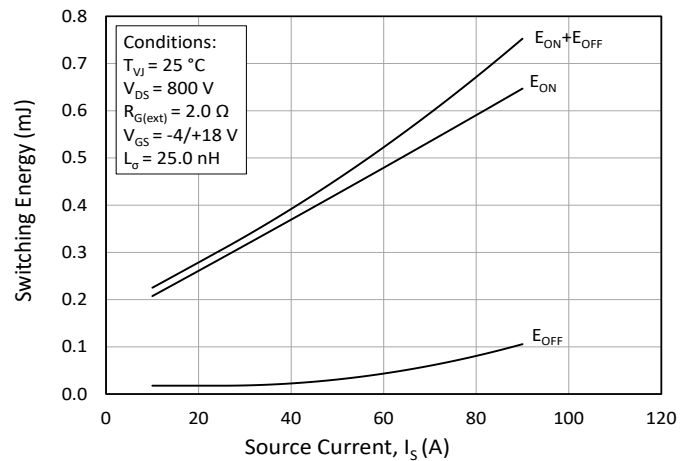


Figure 22. Safe Operating Area

Figure 23. Clamped Inductive Switching Energy vs. Drain Current ($V_{DD} = 600$ V)Figure 24. Clamped Inductive Switching Energy vs. Drain Current ($V_{DD} = 800$ V)

Typical Performance

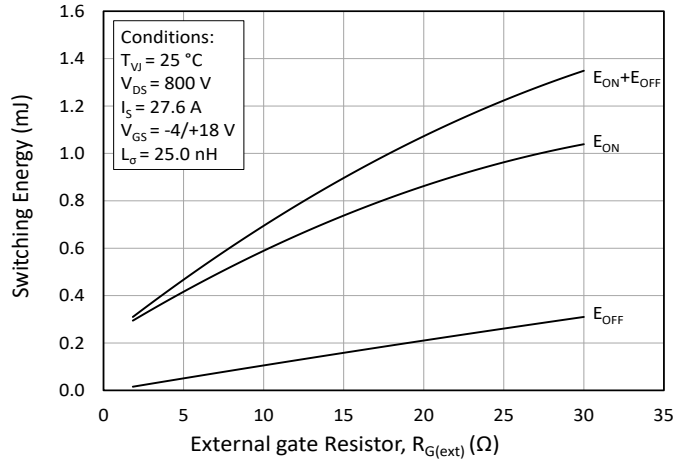
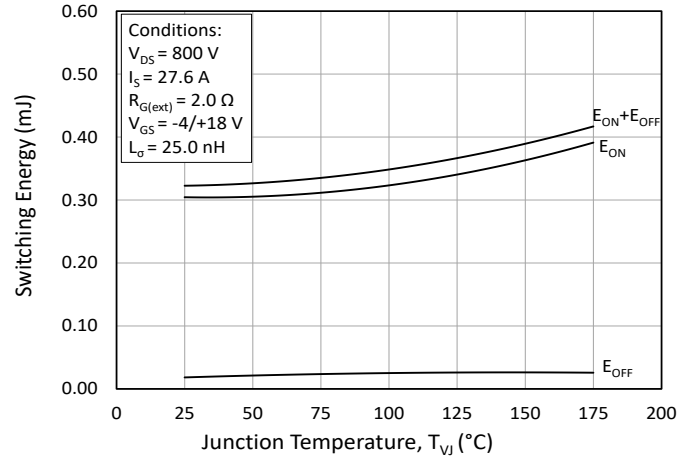
Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$ 

Figure 26. Clamped Inductive Switching Energy vs. Temperature

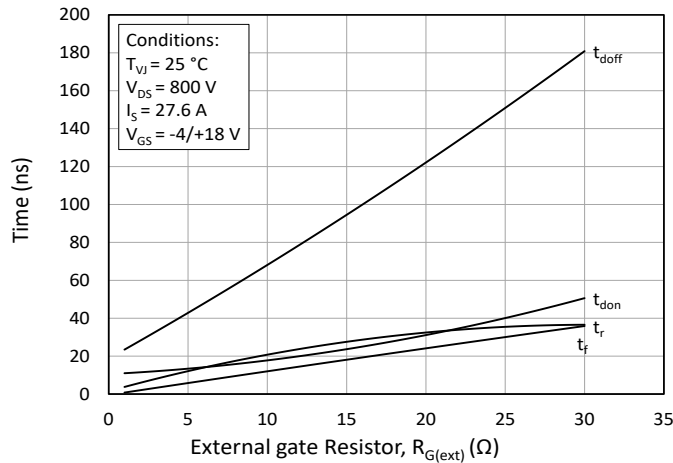
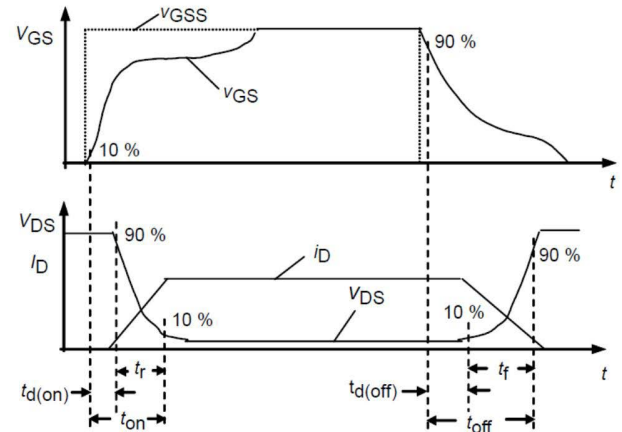
Figure 27. Switching Times vs. $R_{G(ext)}$ 

Figure 28. Switching Times Definition

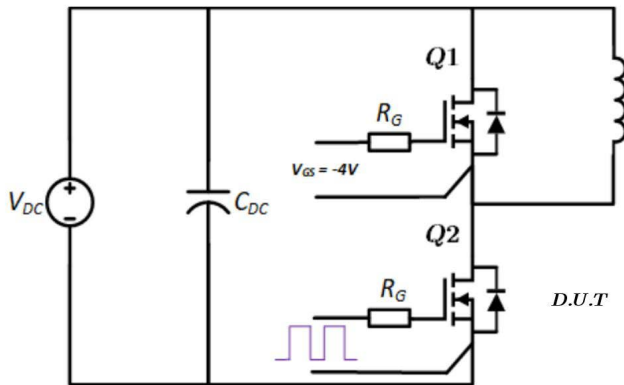


Figure 29. Clamped Inductive MOSFET Switching Waveform Test Circuit

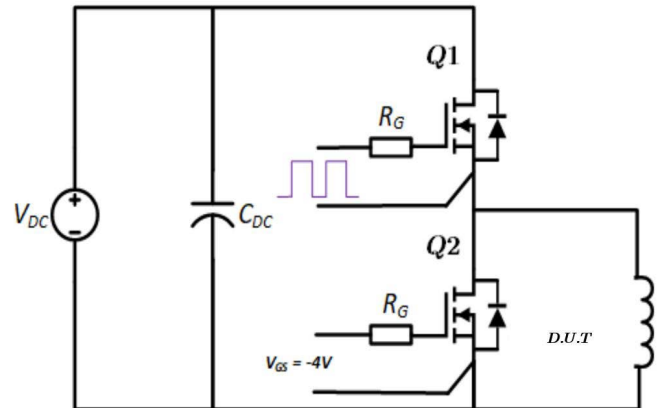
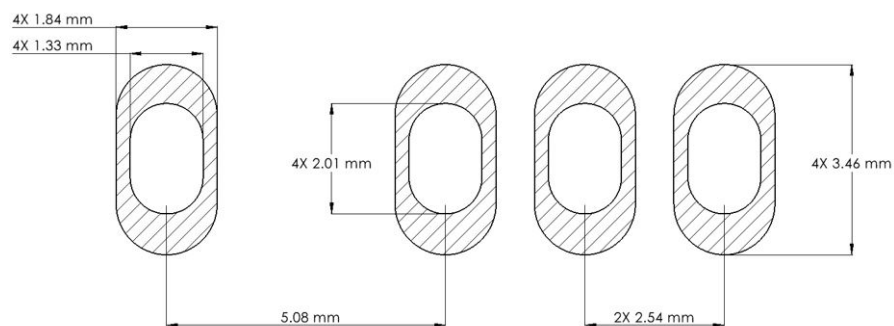


Figure 30. Clamped Inductive Body diode Switching Waveform Test Circuit

Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version	Date of release	Description of changes
1	November 2025	Initial release
2	December 2025	Updated Note 2



Notes & Disclaimer

WOLFSPEED PROVIDES TECHNICAL AND RELIABILITY DATA, DESIGN RESOURCES, APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, WITH RESPECT THERETO, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, SUITABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRDPARTY INTELLECTUAL PROPERTY RIGHTS.

This document and the information contained herein are subject to change without notice. Any such change shall be evidenced by the publication of an updated version of this document by Wolfspeed. No communication from any employee or agent of Wolfspeed or any third party shall effect an amendment or modification of this document. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

The information contained in this document (excluding examples, as well as figures or values that are labeled as “typical”) constitutes Wolfspeed’s sole published specifications for the subject product. “Typical” parameters are the average values expected by Wolfspeed in large quantities and are provided for informational purposes only. Any examples provided herein have not been produced under conditions intended to replicate any specific end use. Product performance can and does vary due to a number of factors.

This product has not been designed or tested for use in, and is not intended for use in, any application in which failure of the product would reasonably be expected to cause death, personal injury, or property damage. For purposes of (but without limiting) the foregoing, this product is not designed, intended, or authorized for use as a critical component in equipment implanted into the human body, life-support machines, cardiac defibrillators, and similar emergency medical equipment; air traffic control systems; or equipment used in the planning, construction, maintenance, or operation of nuclear facilities. Notwithstanding any application-specific information, guidance, assistance, or support that Wolfspeed may provide, the buyer of this product is solely responsible for determining the suitability of this product for the buyer’s purposes, including without limitation (1) selecting the appropriate Wolfspeed products for the buyer’s application, (2) designing, validating, and testing the buyer’s application, and (3) ensuring the buyer’s application meets applicable standards and any other legal, regulatory, and safety-related requirements.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented February 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

Contact info:

4600 Silicon Drive
Durham, NC 27703 USA
Tel: +1.919.313.5300
www.wolfspeed.com/power

© 2025 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc.
PATENT: <https://www.wolfspeed.com/legal/patents>

The information in this document is subject to change without notice.